



# Vincotech

<b>flowMNPC 2</b>		<b>1200 V / 160 A</b>
<b>Features</b>		<b>flow 2 13 mm housing</b>
<ul style="list-style-type: none"><li>• Mixed voltage NPC topology</li><li>• Enhanced reactive power capability</li><li>• Low inductance layout</li><li>• Split output</li><li>• Common collector neutral connection</li></ul>		
<b>Target applications</b>		<b>Schematic</b>
<ul style="list-style-type: none"><li>• Solar Inverters</li></ul>		
<b>Types</b>		
<ul style="list-style-type: none"><li>• 30-FT12NMA160SH04-M669F48</li></ul>		



Vincotech

## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Buck Switch</b>				
Collector-emitter voltage	$V_{CES}$		1200	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	174	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	480	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	447	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$	$V_{GE} = 15\text{ V}$ , $V_{CC} = 800\text{ V}$ $T_j = 150^\circ\text{C}$	10	$\mu\text{s}$
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Buck Diode

Peak repetitive reverse voltage	$V_{RRM}$		650	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	111	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	300	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	142	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Buck Sw. Protection Diode

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	22	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	20	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	56	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$



30-FT12NMA160SH04-M669F48

datasheet

Vincotech

## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Boost Switch</b>				
Collector-emitter voltage	$V_{CES}$		650	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	114	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	640	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	180	W
Gate-emitter voltage	$V_{GES}$		$\pm 30$	V
Short circuit ratings	$t_{SC}$	$V_{GE} = 15\text{ V}$ , $V_{CC} = 360\text{ V}$ $T_j = 25^\circ\text{C}$	2	$\mu\text{s}$
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Boost Diode

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	90	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150^\circ\text{C}$	540	A
Surge current capability	$I^2t$		0	$\text{A}^2\text{s}$
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	181	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Boost Sw. Protection Diode

Peak repetitive reverse voltage	$V_{RRM}$		650	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	36	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	60	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	59	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$



Vincotech

## Maximum Ratings

$T_j = 25 \text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
-----------	--------	------------	-------	------

### Module Properties

Thermal Properties				
--------------------	--	--	--	--

Storage temperature	$T_{stg}$		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	$^\circ\text{C}$

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage*	$t_p = 2 \text{ s}$	4000	V
Isolation voltage	$V_{isol}$	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				min. 12,7	mm
Clearance				min. 12,7	mm
Comparative Tracking Index	CTI			$\geq 200$	

\*100 % tested in production



Vincotech

## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Buck Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,006	25	5,3	5,8	6,3	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		160	25 125 150	1,78	1,94 2,23 2,32	2,42 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			20	µA
Gate-emitter leakage current	$I_{GES}$		20	0		25			480	nA
Internal gate resistance	$r_g$							None		Ω
Input capacitance	$C_{res}$	$f = 1 \text{ MHz}$	0	25	25	25	9320	600	520	pF
Output capacitance	$C_{oes}$									
Reverse transfer capacitance	$C_{res}$									
Gate charge	$Q_g$	$V_{CC} = 960 \text{ V}$	15		160	25		740		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,21		K/W
----------------------------------------------------	---------------	-----------------------------------------------	--	--	--	--	--	------	--	-----

#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	$\pm 15$	350	80	25		132,48		
Rise time	$t_r$					125		132,48		ns
						150		131,52		
Turn-off delay time	$t_{d(off)}$					25		22,72		
						125		26,24		
Fall time	$t_f$					150		27,2		ns
Turn-on energy (per pulse)	$E_{on}$	$Q_{fFWD}=2,54 \mu\text{C}$ $Q_{fFWD}=5,51 \mu\text{C}$ $Q_{fFWD}=6,46 \mu\text{C}$				25		215,04		
						125		293,44		
						150		311,36		
Turn-off energy (per pulse)	$E_{off}$					25		41,69		
						125		97,55		
						150		114,57		ns
						25		1,37		
						125		2,15		
						150		2,4		mWs
						25		2,44		
						125		4,65		
						150		5,33		mWs



Vincotech

## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

## Buck Diode

## Static

Forward voltage	$V_F$				150	25 125 150		1,53 1,49 1,47	1,92 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 650$ V			25			7,6	$\mu$ A	

## Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,67		K/W
----------------------------------------------------	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

## Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=4251$ A/ $\mu$ s $di/dt=3763$ A/ $\mu$ s $di/dt=3925$ A/ $\mu$ s	$\pm 15$	350	80	25		61,93		A
Reverse recovery time	$t_{rr}$					125		88,59		
Recovered charge	$Q_r$					150		94,22		
Recovered charge	$Q_r$		$\pm 15$	350	80	25		61,9		ns
Reverse recovered energy	$E_{rec}$					125		94,72		
Reverse recovered energy	$E_{rec}$					150		106,85		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		$\pm 15$	350	80	25		2,54		$\mu$ C
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		5,51		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		6,46		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		$\pm 15$	350	80	25		0,478		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		1,05		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		1,2		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		$\pm 15$	350	80	25		1800		A/ $\mu$ s
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		1442		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		1087		



30-FT12NMA160SH04-M669F48

datasheet

Vincotech

## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Buck Sw. Protection Diode

#### Static

Forward voltage	$V_F$				10	25 125 150	1,35	1,79 1,77 1,73	2,05 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_T = 1200$ V				25			2,7	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,68		K/W
----------------------------------------------------	---------------	---------------------------------------	--	--	--	--	--	------	--	-----



30-FT12NMA160SH04-M669F48

datasheet

Vincotech

## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	

### Boost Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$			5	0,1142	25	5	6	7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		160	25 125 150		1,64 1,69 1,75	1,9 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	650		25			20	µA
Gate-emitter leakage current	$I_{GES}$		30	0		25			400	nA
Internal gate resistance	$r_g$							None		Ω
Input capacitance	$C_{res}$	$f = 1 \text{ MHz}$	0	30	25			9620		pF
Output capacitance	$C_{oes}$							368		pF
Reverse transfer capacitance	$C_{res}$							158		pF
Gate charge	$Q_g$		15	400	160	25		342		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,53		K/W
----------------------------------------------------	---------------	-----------------------------------------------	--	--	--	--	--	------	--	-----

#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	$\pm 15$	350	80	25		142,72		
Rise time	$t_r$					125		140,8		ns
						150		139,84		
Turn-off delay time	$t_{d(off)}$					25		15,68		
						125		16,96		
Fall time	$t_f$					150		17,28		
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD}=3,44 \mu\text{C}$ $Q_{fFWD}=8,62 \mu\text{C}$ $Q_{ffwd}=10,46 \mu\text{C}$				25		118,4		
						125		136,32		
						150		143,04		
Turn-off energy (per pulse)	$E_{off}$					25		36,92		
						125		57,78		
						150		67,88		
						25		0,909		
						125		1,34		mWs
						150		1,47		
						25		1,6		
						125		2,37		
						150		2,68		mWs



Vincotech

## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

## Boost Diode

## Static

Forward voltage	$V_F$				100	25 125 150		2,21 2,31 2,22	2,54 <sup>(1)</sup> 2,5 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_F = 1200$ V				25 150		8800	120 17600	μA

## Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,52		K/W
----------------------------------------------------	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

## Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=6053$ A/μs $di/dt=5451$ A/μs $di/dt=5300$ A/μs	$\pm 15$	350	80	25 125 150		137,23 165,59 176,18		A
Reverse recovery time	$t_{rr}$					25 125 150		43,24 134,94 154,88		ns
Recovered charge	$Q_r$					25 125 150		3,44 8,62 10,46		μC
Reverse recovered energy	$E_{rec}$		$\pm 15$	350	80	25 125 150		0,771 2,21 2,69		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		8803 7078 6667		A/μs



30-FT12NMA160SH04-M669F48

datasheet

Vincotech

## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max

### Boost Sw. Protection Diode

#### Static

Forward voltage	$V_F$				30	25 125	1,23	1,7 1,59	1,87 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 650$ V				25			0,36	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,61		K/W
----------------------------------------------------	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

### Thermistor

#### Static

Rated resistance	$R$					25		22		kΩ
Deviation of $R_{100}$	$A_{R/R}$	$R_{100} = 1486$ Ω				100	-12		14	%
Power dissipation	$P$							200		mW
Power dissipation constant	$d$					25		2		mW/K
B-value	$B_{(25/50)}$	Tol. ±3 %						3950		K
B-value	$B_{(25/100)}$	Tol. ±3 %						3998		K
Vincotech Thermistor Reference									B	

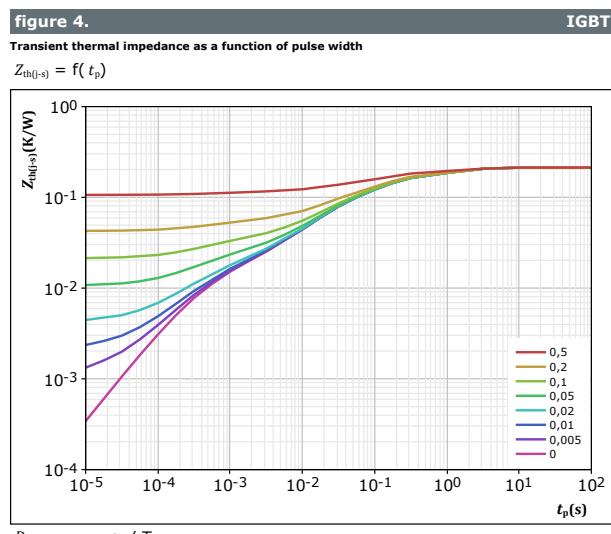
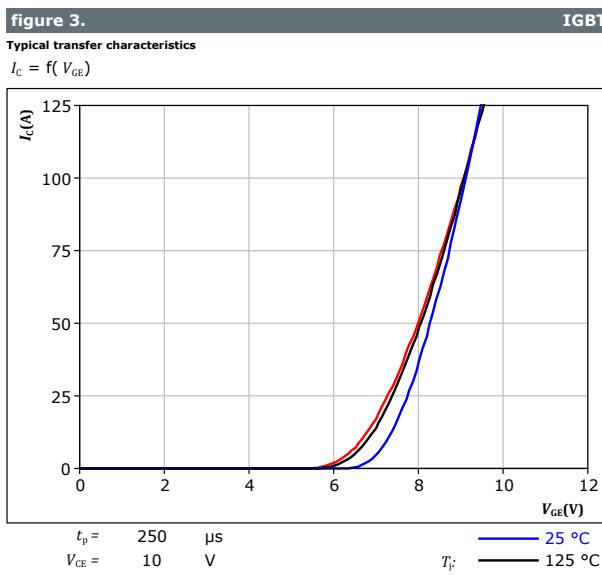
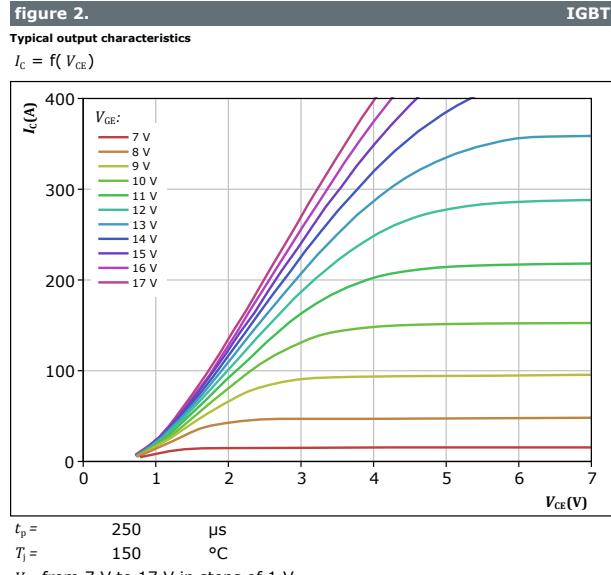
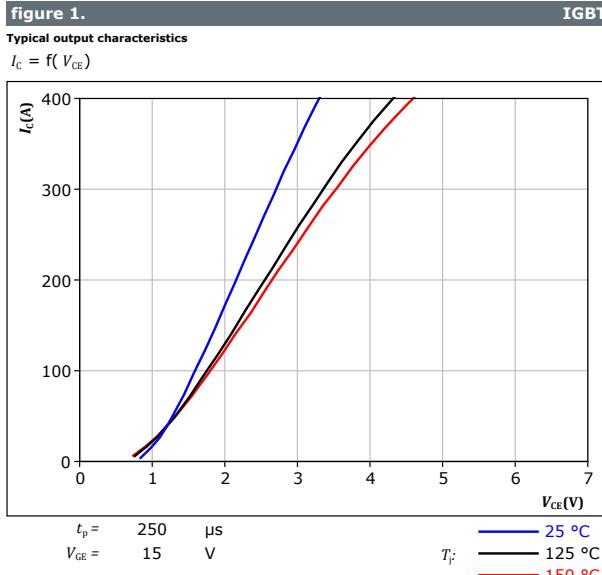
<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.



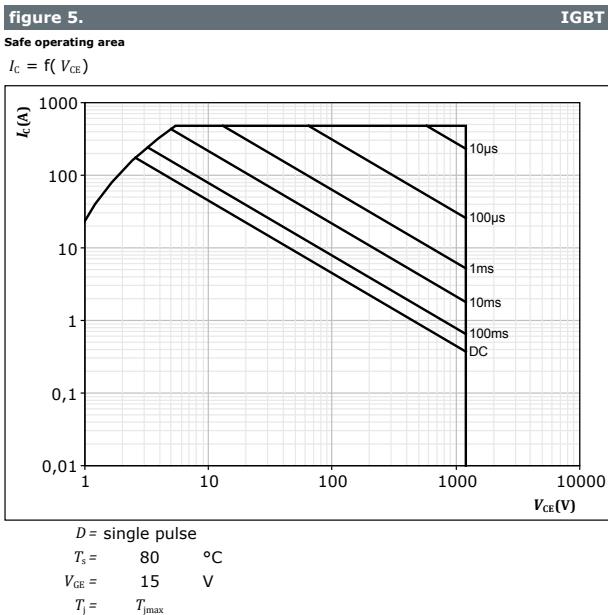
Vincotech

## Buck Switch Characteristics



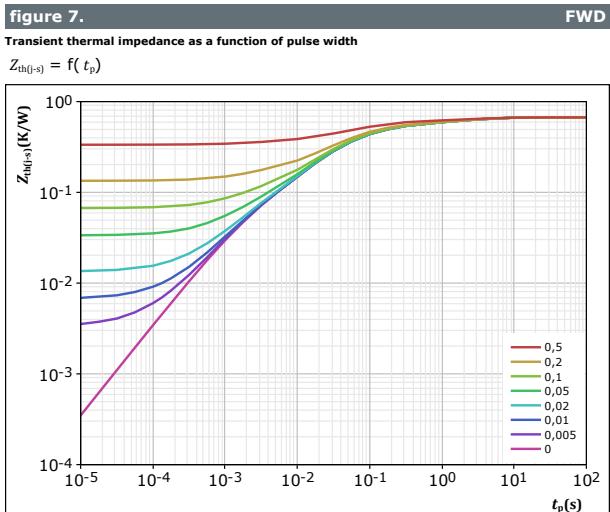
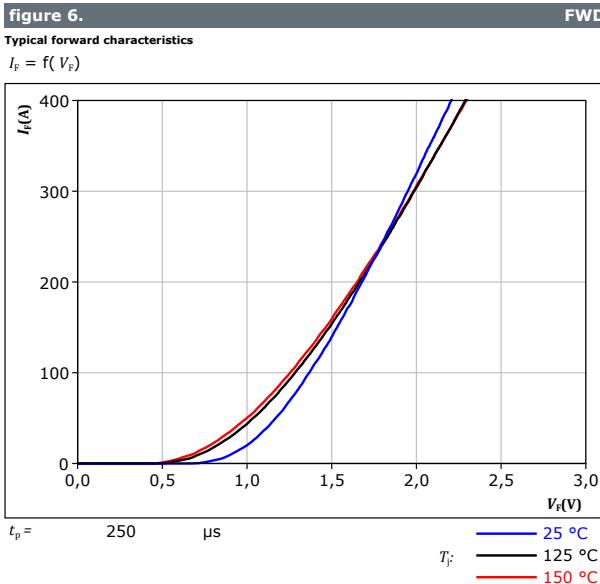


## Buck Switch Characteristics





## Buck Diode Characteristics





Vincotech

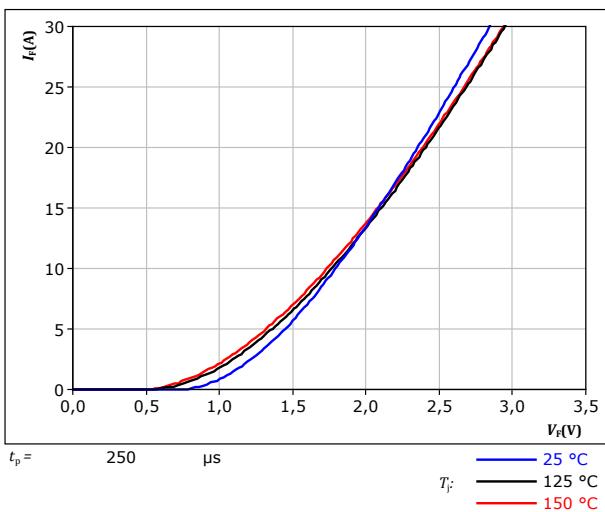
## Buck Sw. Protection Diode Characteristics

figure 8.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

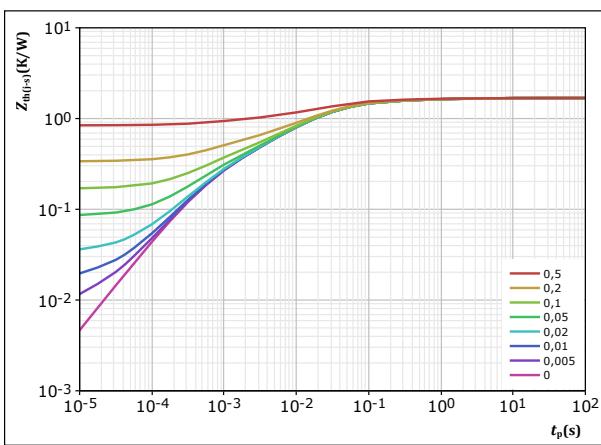
$$T_J: \begin{cases} 25^\circ\text{C} \\ 125^\circ\text{C} \\ 150^\circ\text{C} \end{cases}$$

figure 9.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p}{T} = 1,683$$

K/W

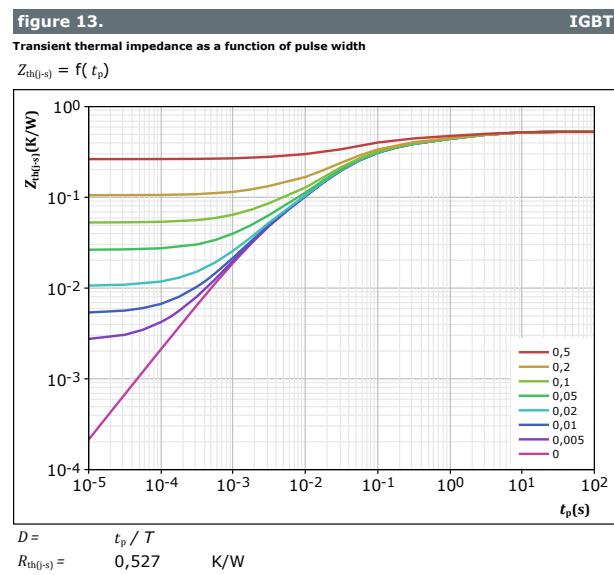
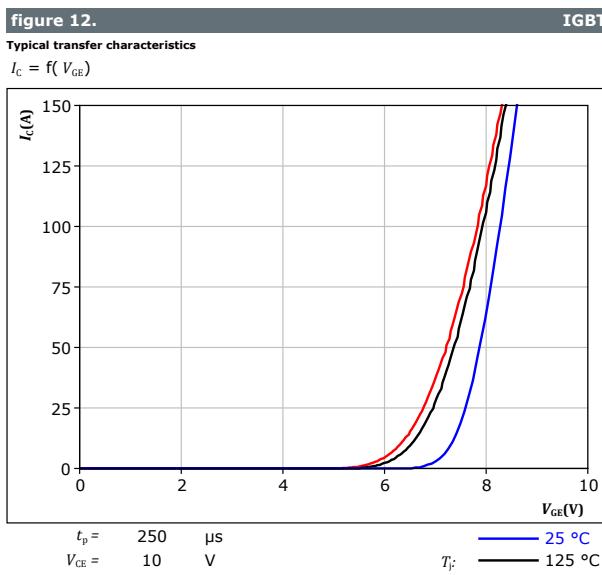
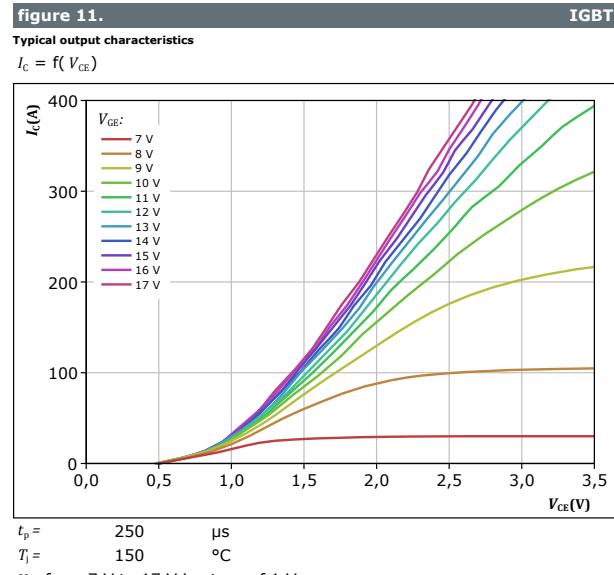
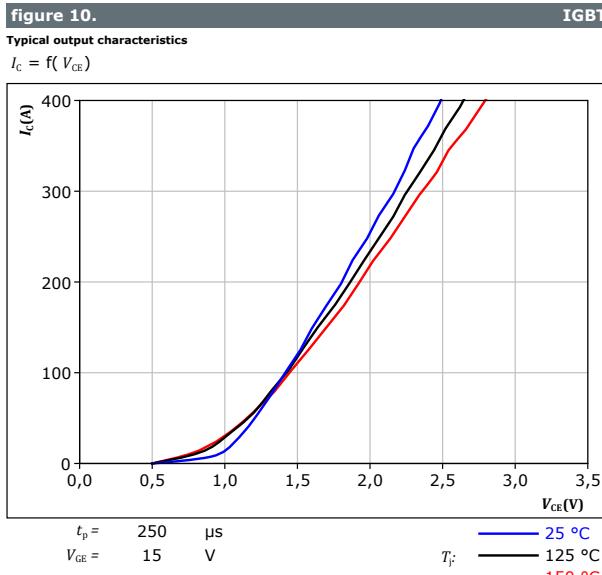
FWD thermal model values

$R$ (K/W)	$\tau$ (s)
6,27E-02	2,99E+00
1,53E-01	2,72E-01
5,57E-01	4,10E-02
4,90E-01	1,29E-02
2,45E-01	3,00E-03
1,75E-01	5,24E-04



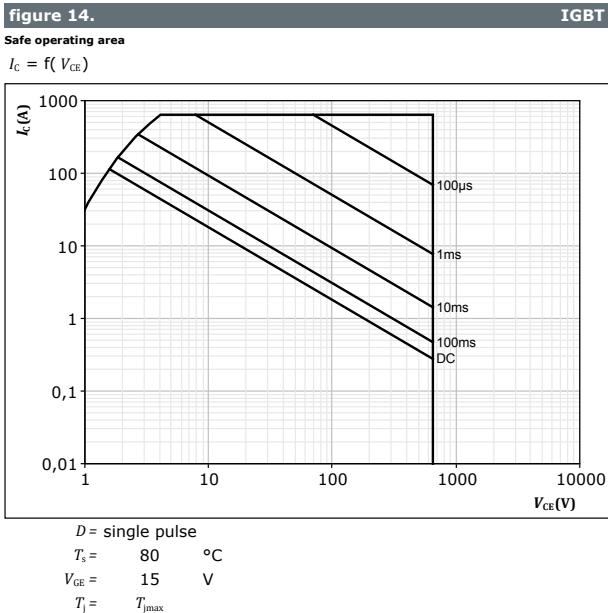
Vincotech

## Boost Switch Characteristics





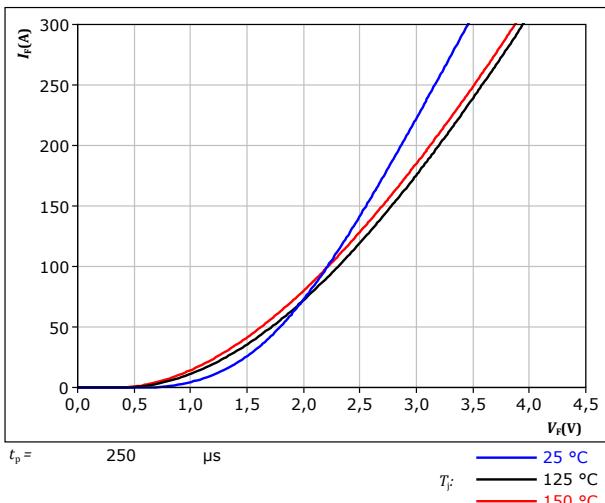
## Boost Switch Characteristics





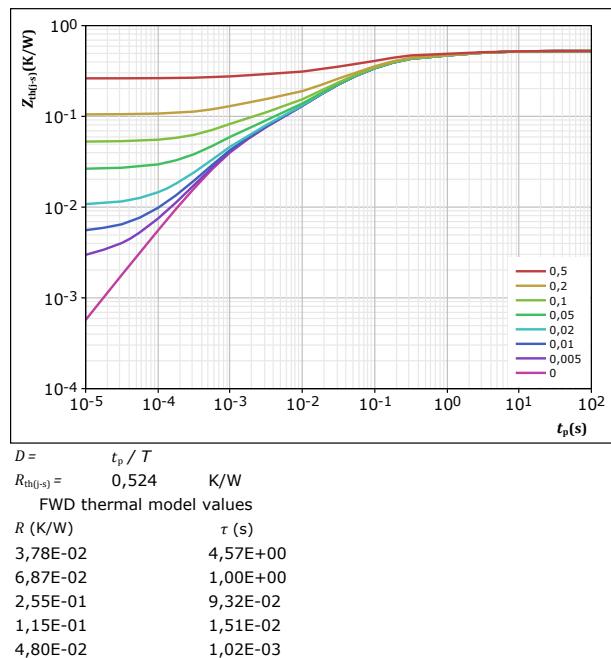
## Boost Diode Characteristics

**figure 15.**  
Typical forward characteristics  
 $I_F = f(V_F)$



FWD

**figure 16.**  
Transient thermal impedance as a function of pulse width  
 $Z_{th(j-s)} = f(t_p)$



FWD



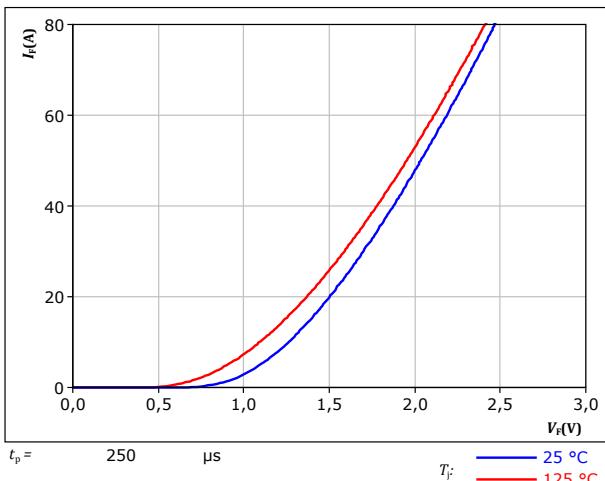
Vincotech

## Boost Sw. Protection Diode Characteristics

figure 17.

Typical forward characteristics

$$I_F = f(V_F)$$

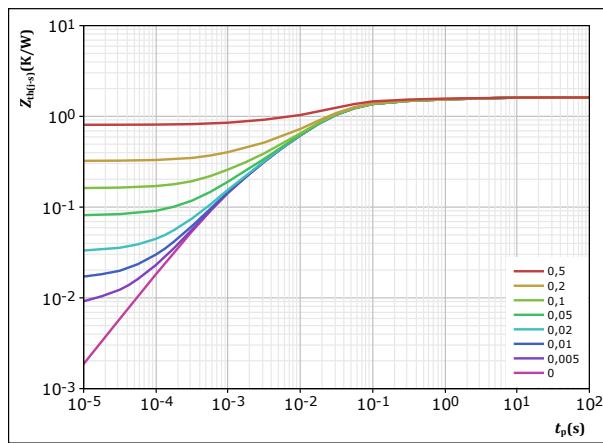


FWD

figure 18.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



FWD

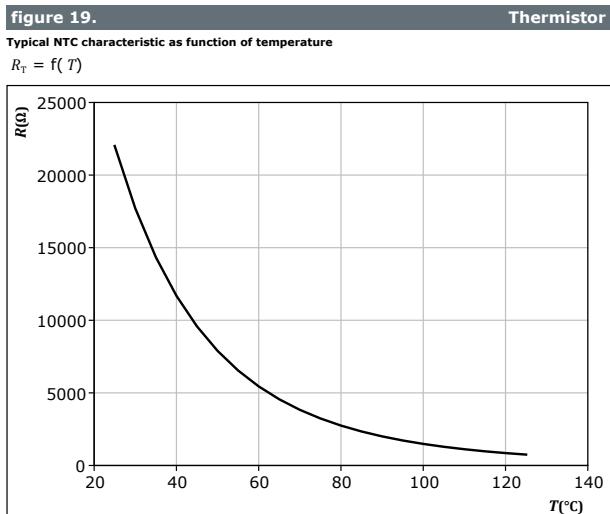
$$D = \frac{t_p / T}{1,614} \quad K/W$$

FWD thermal model values

$R$ (K/W)	$\tau$ (s)
1,05E-01	3,05E+00
1,86E-01	2,04E-01
8,60E-01	3,00E-02
3,40E-01	8,15E-03
1,24E-01	1,07E-03



## Thermistor Characteristics





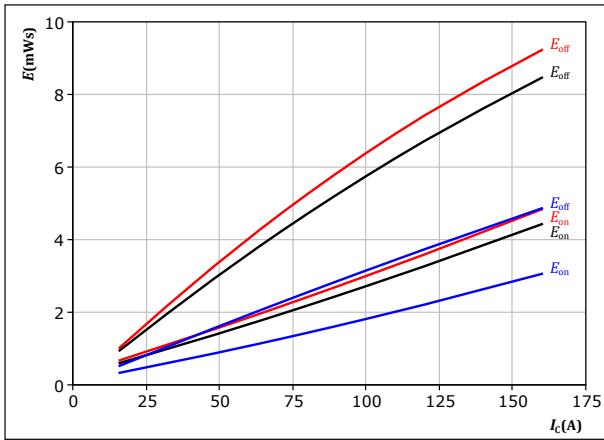
Vincotech

## Buck Switching Characteristics

figure 20.

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

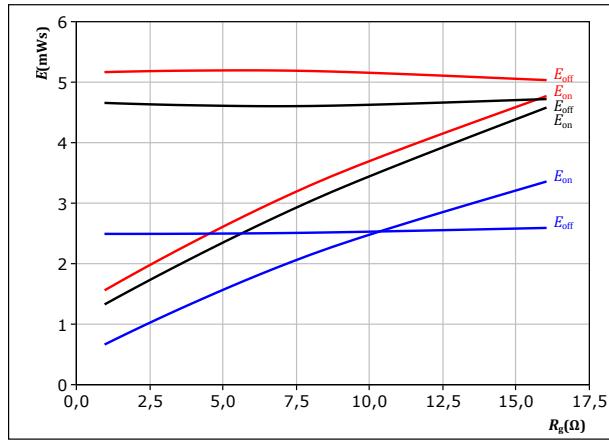
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f: & 25^\circ\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & 125^\circ\text{C} \\ R_{gon} &= 4 \Omega & & 150^\circ\text{C} \\ R_{goff} &= 4 \Omega \end{aligned}$$

IGBT

figure 21.

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

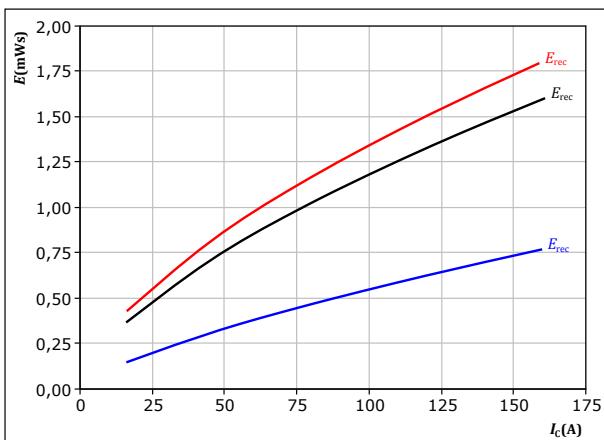
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f: & 25^\circ\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & 125^\circ\text{C} \\ I_c &= 80 \text{ A} & & 150^\circ\text{C} \end{aligned}$$

IGBT

figure 22.

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

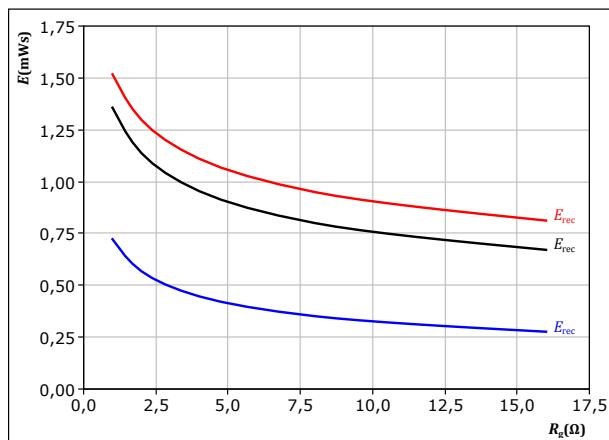
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f: & 25^\circ\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & 125^\circ\text{C} \\ R_{gon} &= 4 \Omega & & 150^\circ\text{C} \end{aligned}$$

FWD

figure 23.

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f: & 25^\circ\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & 125^\circ\text{C} \\ I_c &= 80 \text{ A} & & 150^\circ\text{C} \end{aligned}$$

FWD

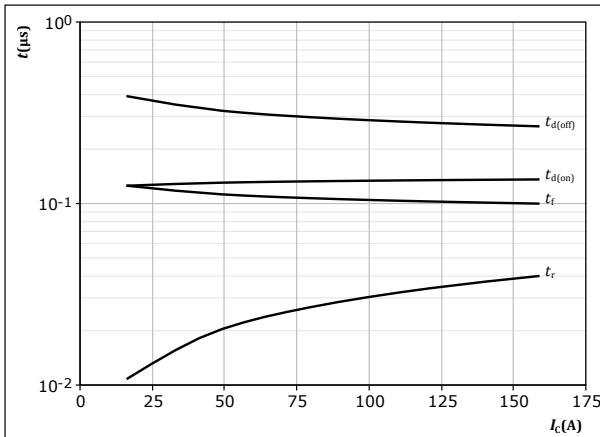


Vincotech

## Buck Switching Characteristics

figure 24. IGBT

Typical switching times as a function of collector current  
 $t = f(I_C)$

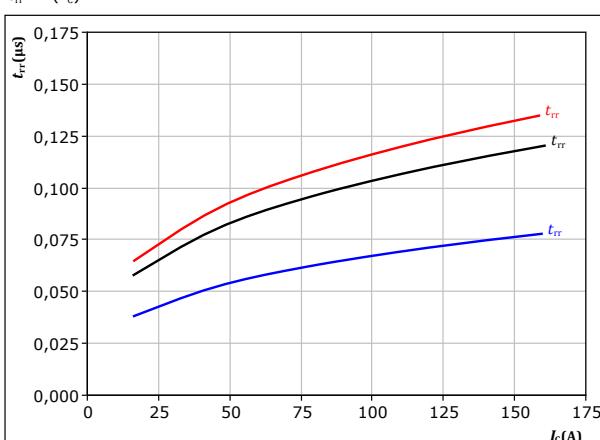


With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

figure 26. FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$

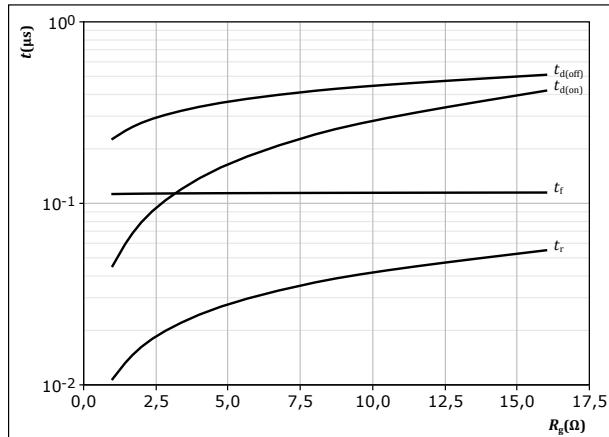


With an inductive load at

$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω

figure 25. IGBT

Typical switching times as a function of gate resistor  
 $t = f(R_g)$

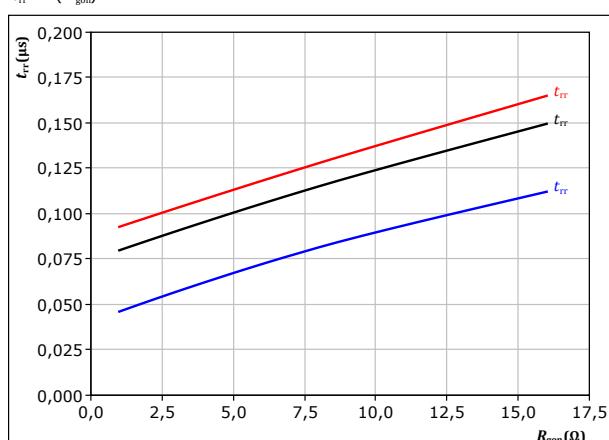


With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$I_C =$	80	A

figure 27. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$I_C =$	80	A



Vincotech

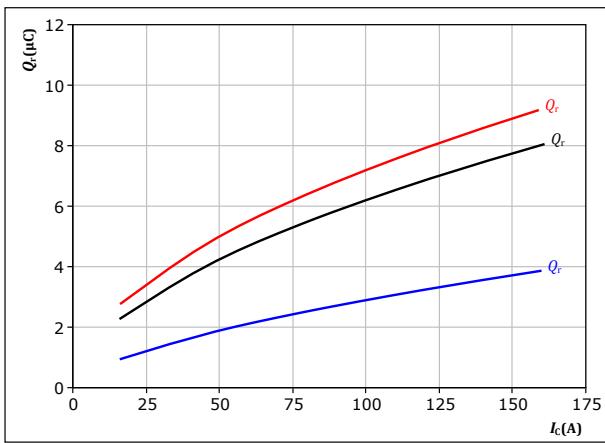
## Buck Switching Characteristics

figure 28.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

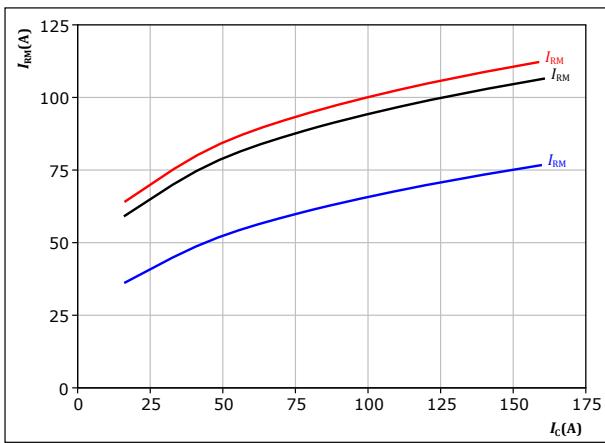
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 4 \Omega & & \end{aligned}$$

figure 30.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

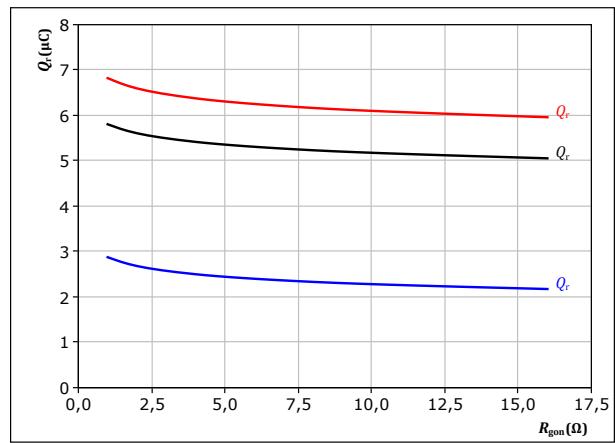
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 4 \Omega & & \end{aligned}$$

figure 29.

FWD

Typical recovered charge as a function of turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

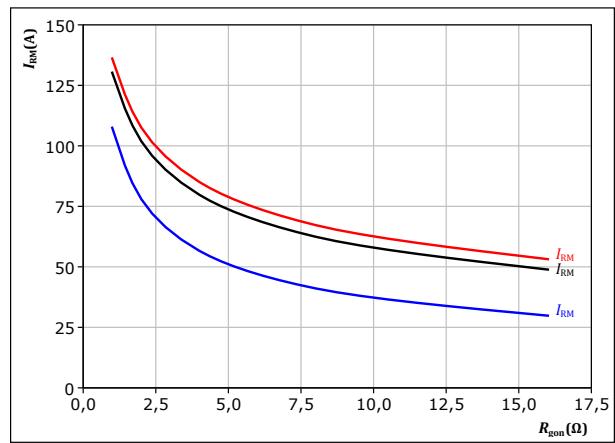
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 80 \text{ A} & & \end{aligned}$$

figure 31.

FWD

Typical peak reverse recovery current as a function of turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ °C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 80 \text{ A} & & \end{aligned}$$



Vincotech

## Buck Switching Characteristics

figure 32. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_f/dt, di_{rr}/dt = f(I_c)$

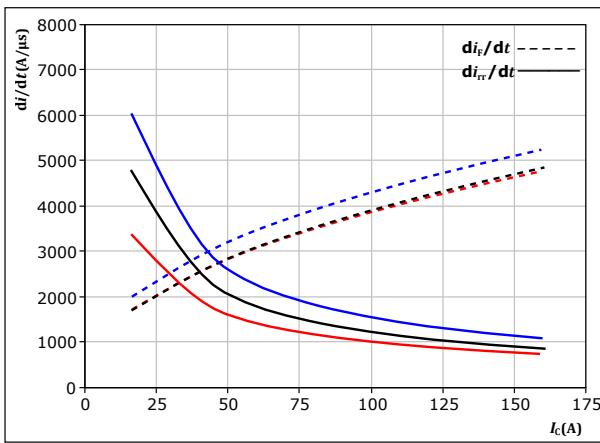


figure 33. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor

$di_f/dt, di_{rr}/dt = f(R_{gon})$

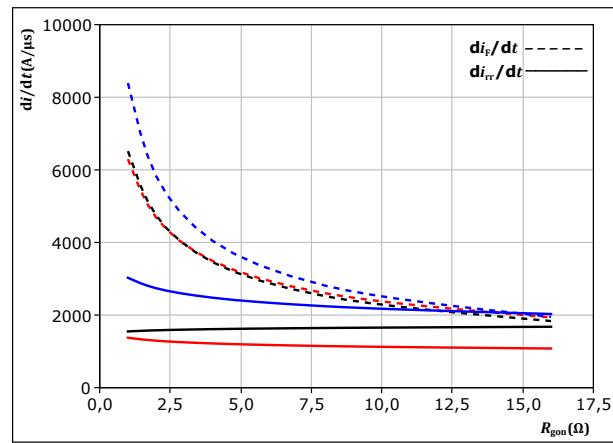
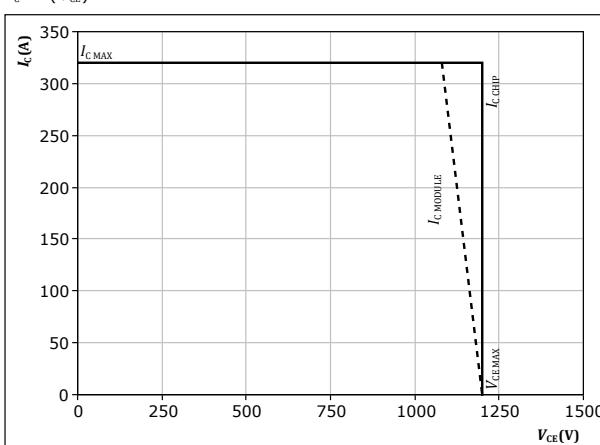


figure 34. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



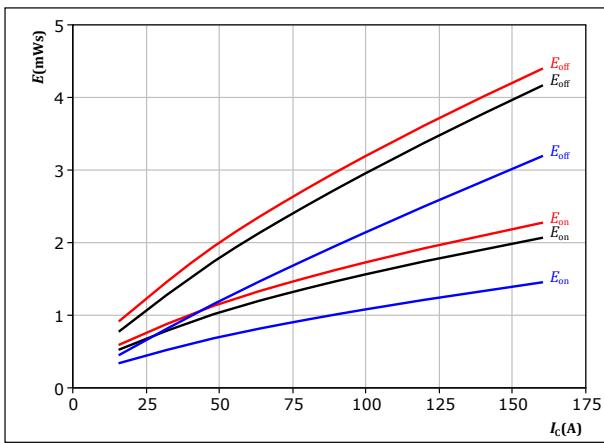


Vincotech

## Boost Switching Characteristics

figure 35.

Typical switching energy losses as a function of collector current  
 $E = f(I_c)$



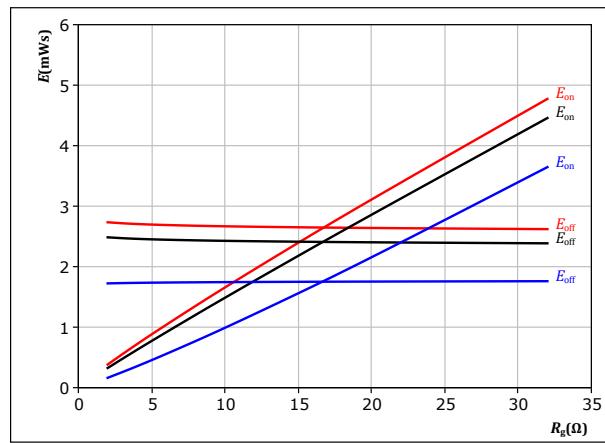
With an inductive load at

$V_{CE} = 350$  V       $T_f = 125$  °C  
 $V_{GE} = \pm 15$  V       $E_{off}$   
 $R_{gon} = 8$  Ω       $E_{on}$   
 $R_{goff} = 8$  Ω

IGBT

figure 36.

Typical switching energy losses as a function of gate resistor  
 $E = f(R_g)$



With an inductive load at

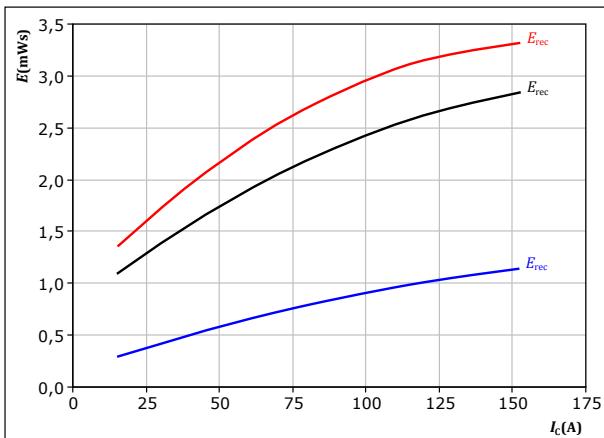
$V_{CE} = 350$  V       $T_f = 125$  °C  
 $V_{GE} = \pm 15$  V       $E_{on}$   
 $I_c = 80$  A       $E_{off}$

IGBT

figure 37.

Typical reverse recovered energy loss as a function of collector current

$E_{rec} = f(I_c)$



With an inductive load at

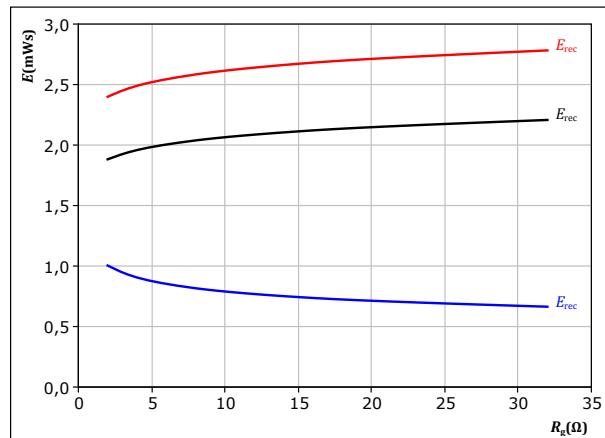
$V_{CE} = 350$  V       $T_f = 125$  °C  
 $V_{GE} = \pm 15$  V       $E_{rec}$   
 $R_{gon} = 8$  Ω

FWD

figure 38.

Typical reverse recovered energy loss as a function of gate resistor

$E_{rec} = f(R_g)$



With an inductive load at

$V_{CE} = 350$  V       $T_f = 125$  °C  
 $V_{GE} = \pm 15$  V       $E_{rec}$   
 $I_c = 80$  A

FWD

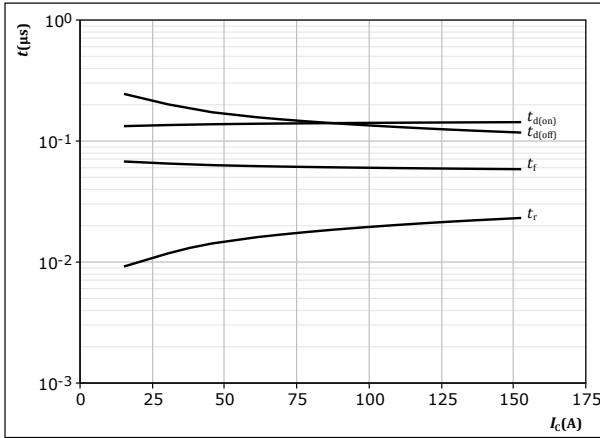


Vincotech

## Boost Switching Characteristics

**figure 39.** IGBT

Typical switching times as a function of collector current  
 $t = f(I_C)$

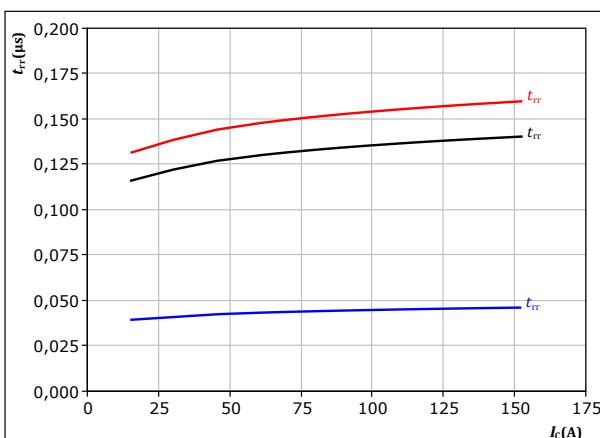


With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 8 \Omega$   
 $R_{goff} = 8 \Omega$

**figure 41.** FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$

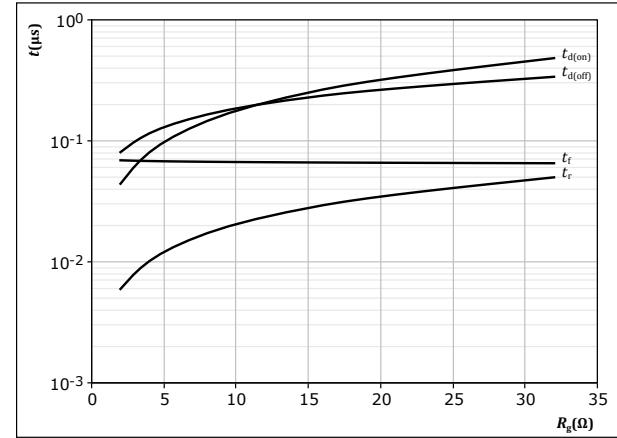


With an inductive load at

$V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 8 \Omega$

**figure 40.** IGBT

Typical switching times as a function of gate resistor  
 $t = f(R_g)$

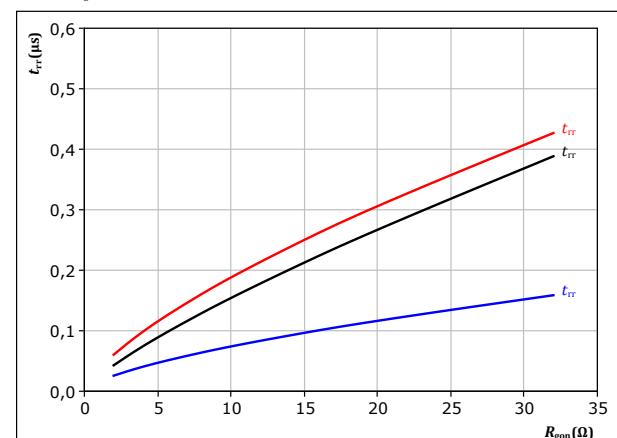


With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 80 \text{ A}$

**figure 42.** FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 80 \text{ A}$



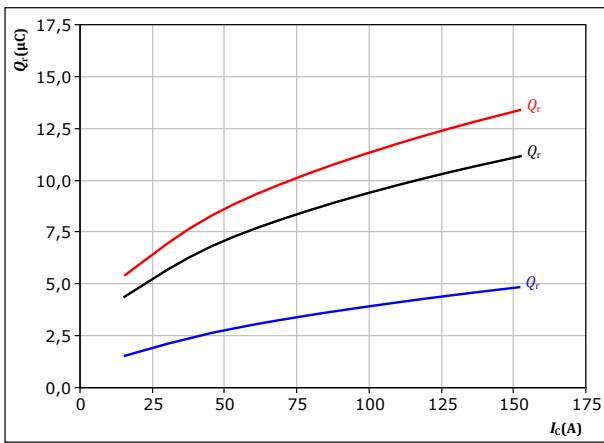
Vincotech

## Boost Switching Characteristics

figure 43.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

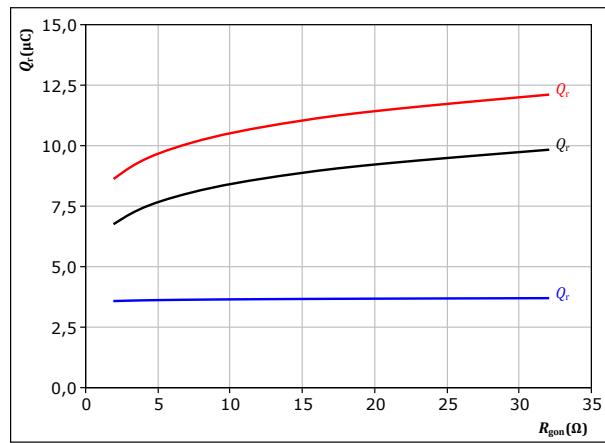
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 8 \Omega & I_c &= 80 \text{ A} \end{aligned}$$

FWD

figure 44.

Typical recovered charge as a function of turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

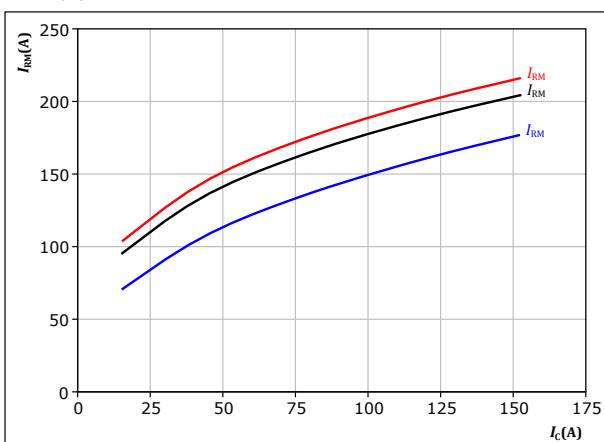
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 80 \text{ A} & R_{gon} &= 1 \Omega \end{aligned}$$

FWD

figure 45.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

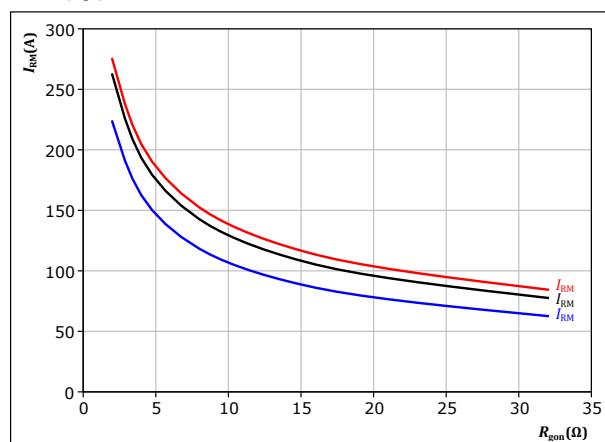
$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ R_{gon} &= 8 \Omega & I_c &= 80 \text{ A} \end{aligned}$$

FWD

figure 46.

Typical peak reverse recovery current as a function of turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 350 \text{ V} & T_f &= 25 \text{ }^{\circ}\text{C} \\ V_{GE} &= \pm 15 \text{ V} & & \\ I_c &= 80 \text{ A} & R_{gon} &= 1 \Omega \end{aligned}$$

FWD



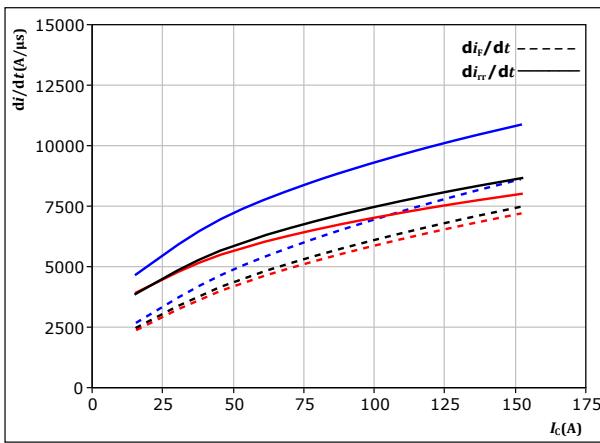
Vincotech

## Boost Switching Characteristics

**figure 47.** FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_f/dt, di_{rr}/dt = f(I_c)$



With an inductive load at

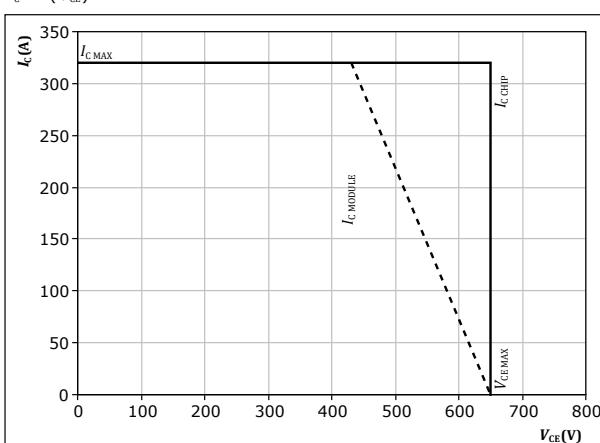
$V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$  Ω

$T_j =$  25 °C  
125 °C  
150 °C

**figure 49.** IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$

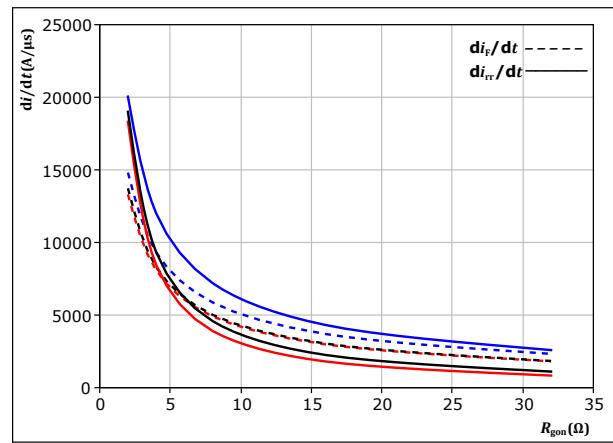


At  $T_j = 150$  °C  
 $R_{gon} = 8$  Ω  
 $R_{goff} = 8$  Ω

**figure 48.** FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor

$di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 80$  A

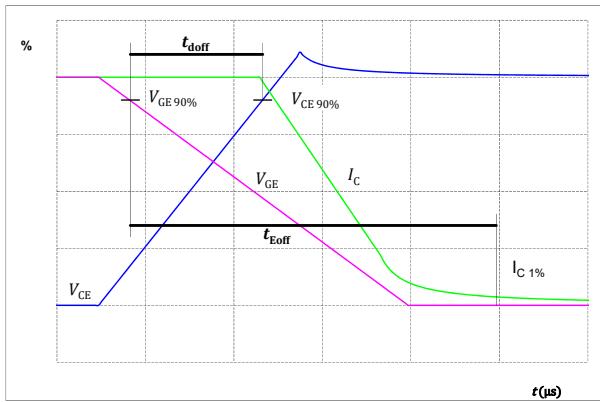


Vincotech

## Switching Definitions

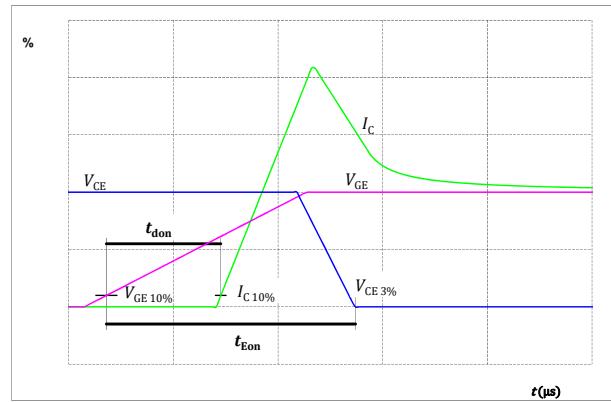
**figure 50.** IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



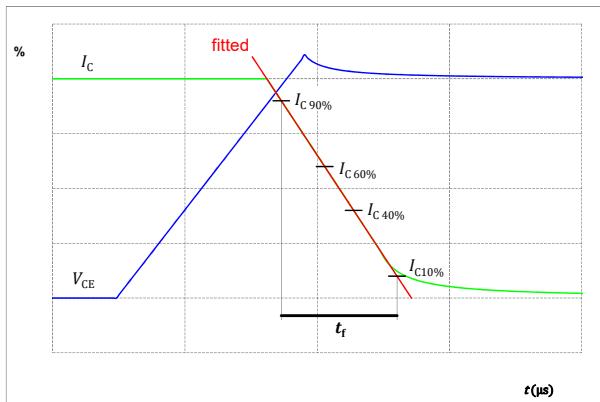
**figure 51.** IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



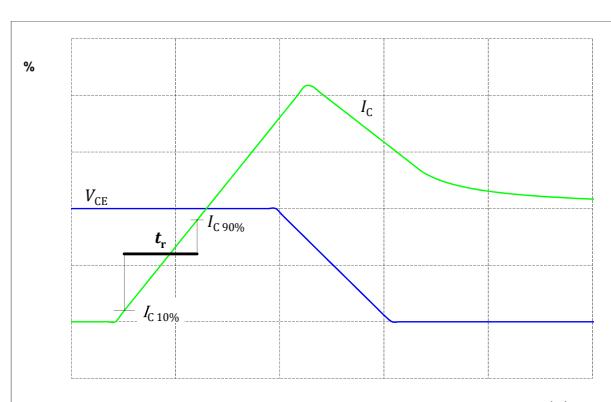
**figure 52.** IGBT

Turn-off Switching Waveforms & definition of  $t_f$



**figure 53.** IGBT

Turn-on Switching Waveforms & definition of  $t_r$





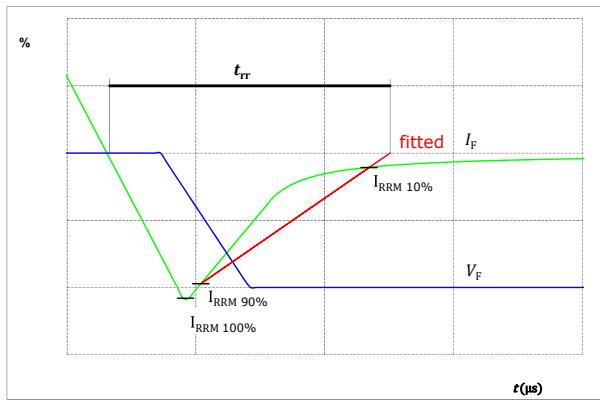
Vincotech

## Switching Definitions

**figure 54.**  
Turn-off Switching Waveforms & definition of  $t_{tr}$

FWD

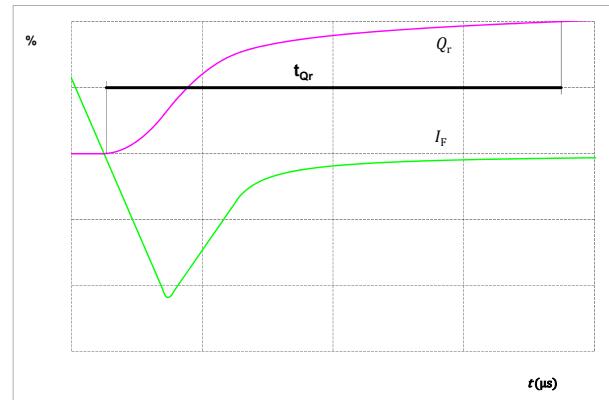
Turn-off Switching Waveforms & definition of  $t_{tr}$



**figure 55.**  
Turn-on Switching Waveforms & definition of  $t_{qr}$  ( $t_{qr}$  = integrating time for  $Q_r$ )

FWD

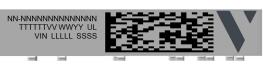
Turn-on Switching Waveforms & definition of  $t_{qr}$  ( $t_{qr}$  = integrating time for  $Q_r$ )

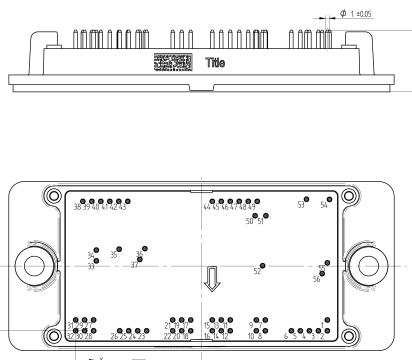


**30-FT12NMA160SH04-M669F48**

datasheet

**Vincotech**

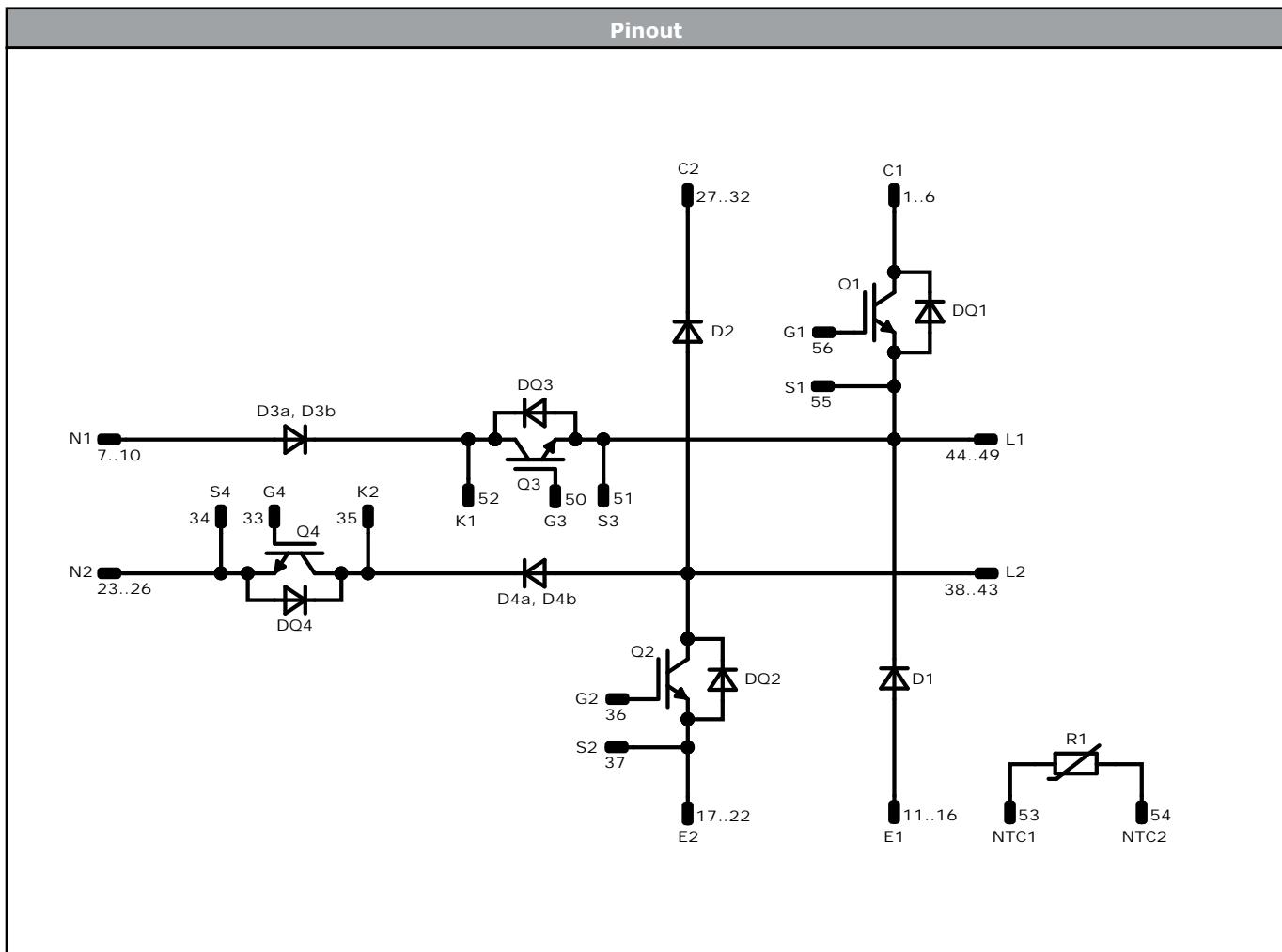
Ordering Code							
Version				Ordering Code			
Without thermal paste				30-FT12NMA160SH04-M669F48			
With thermal paste				30-FT12NMA160SH04-M669F48-/3/			
Marking							
		Text	Name	Date code	UL & VIN	Lot	Serial
			NN-NNNNNNNNNNNN- YYYY-LL-SSSS	WWYY	UL VIN	LLLL	SSSS
Datamatrix		Type&Ver	Lot number	Serial	Date code		
		TTTTTTVV	LLLLL	SSSS	WWYY		
Outline							
Pin table [mm]							
Pin	X	Y	Function	29	2,5	3	C2
1	70	3	C1	30	2,5	0	C2
2	70	0	C1	31	0	3	C2
3	67,5	0	C1	32	0	0	C2
4	65	0	C1	33	5,75	19,45	G4
5	62,5	0	C1	34	5,75	22,45	S4
6	60	0	C1	35	12,1	22,7	K2
7	52,75	3	N1	36	19,25	22,85	G2
8	52,75	0	N1	37	17,85	19,85	S2
9	50,25	3	N1	38	2	36	L2
10	50,25	0	N1	39	4,5	36	L2
11	43	3	E1	40	7	36	L2
12	43	0	E1	41	9,5	36	L2
13	40,5	3	E1	42	12	36	L2
14	40,5	0	E1	43	14,5	36	L2
15	38	3	E1	44	38	36	L1
16	38	0	E1	45	40,5	36	L1
17	32	3	E2	46	43	36	L1
18	32	0	E2	47	45,5	36	L1
19	29,5	3	E2	48	48	36	L1
20	29,5	0	E2	49	50,5	36	L1
21	27	3	E2	50	49,9	32	G3
22	27	0	E2	51	52,9	32	S3
23	19,75	0	N2	52	52	18,1	K1
24	17,25	0	N2	53	64,2	36,6	NTC
25	14,75	0	N2	54	70,6	36,55	NTC
26	12,25	0	N2	55	70	18,9	S1
27	5	3	C2	56	68,55	15,9	G1
28	5	0	C2				



Tolerance of positions: ±0,5mm at the end of pins.  
Dimension of coordinate axis is only offset without tolerance.



Vincotech



### Identification

ID	Component	Voltage	Current	Function	Comment
Q1, Q2	IGBT	1200 V	160 A	Buck Switch	
D3, D4	FWD	650 V	150 A	Buck Diode	
DQ1, DQ2	FWD	1200 V	10 A	Buck Sw. Protection Diode	
Q4, Q3	IGBT	650 V	160 A	Boost Switch	
D2, D1	FWD	1200 V	100 A	Boost Diode	
DQ4, DQ3	FWD	650 V	30 A	Boost Sw. Protection Diode	
NTC	NTC			Thermistor	

**30-FT12NMA160SH04-M669F48**

datasheet

**Vincotech****Packaging instruction**

Standard packaging quantity (SPQ) 36	>SPQ	Standard	<SPQ	Sample
--------------------------------------	------	----------	------	--------

**Handling instruction**

Handling instructions for flow 2 packages see vincotech.com website.

**Package data**

Package data for flow 2 packages see vincotech.com website.

**Vincotech thermistor reference**

See Vincotech thermistor reference table at vincotech.com website.

**UL recognition and file number**

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
30-FT12NMA160SH04-M669F48-D1-14	29 Sep. 2020		

**DISCLAIMER**

The information, specifications, procedures, methods and recommendations herein (together "information") are presented by Vincotech to reader in good faith, are believed to be accurate and reliable, but may well be incomplete and/or not applicable to all conditions or situations that may exist or occur. Vincotech reserves the right to make any changes without further notice to any products to improve reliability, function or design. No representation, guarantee or warranty is made to reader as to the accuracy, reliability or completeness of said information or that the application or use of any of the same will avoid hazards, accidents, losses, damages or injury of any kind to persons or property or that the same will not infringe third parties rights or give desired results. It is reader's sole responsibility to test and determine the suitability of the information and the product for reader's intended use.

**LIFE SUPPORT POLICY**

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.